AMENDMENTS TO THE CLAIMS

The following is a complete, marked up listing of revised claims with a status identifier in parentheses, underlined text indicating insertions, and strikethrough and/or double brackets indicating deletions.

Listing of the Claims

1. (CURRENTLY AMENDED) A DNA chip, comprising:

a flat carrier; and

an array of spots containing catcher molecules, each spot being assigned a microelectrode arrangement for detecting binding events between the catcher molecules and target molecules applied via an analyte solution, the electrode arrangement being at least partially embedded in a hydrophilic reaction layer which is permeable to target molecules and in which immobilized catcher molecules are distributed three-dimensionally,

the hydrophilic reaction layer having a thickness approximately in the range of 1L to 5–L5L, L being the sum of electrode width and electrode spacing.

the electrode width and the electrode spacing being approximately lum, and

the hydrophilic reaction layer having a thickness between 2µm and 10µm.

2.-4. (CANCELLED)

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- 5. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the microelectrode arrangement is a two-pole system, and wherein the reaction layer has a thickness of approximately 3 µm.
- 6. (Previously Presented) The DNA chip as claimed in claim 1, wherein the microelectrode arrangement is a four-pole system, and wherein the reaction layer has a thickness of approximately 7 µm.
- 7. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the reaction layer is thermally stable up to approximately 95°C.
- 8. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the reaction layer contains coupling groups for the covalent binding of catcher molecules.
- 9. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the reaction layer is a hydrogel.
- 10. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 6, wherein an acrylamide-based radical-crosslinkable hydrogel includes at least one of maleic anhydride and glycidyl (meth)acrylate as coupling groups.

- 11. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the electrode arrangement is an interdigital electrode arrangement.
- 12. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 11, wherein the interdigital electrode arrangement is a two-pole microelectrode system.
- 13. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 11, wherein the interdigital electrode arrangement is a four-pole microelectrode system.
- 14. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 1, wherein the flat carrier includes a semiconductor layer and an insulating layer connected thereto, the insulating layer carrying the electrode arrangement and the reaction layer on its side remote from the semiconductor layer.
- 15. (PREVIOUSLY PRESENTED) The DNA chip as claimed in claim 14, wherein the semiconductor layer is a silicon layer.
 - 16.-20. (CANCELLED)